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Number: PMP9486	Rev: E1	Designed for: Texas Instruments Corporation	Date: 9/19/2014
SVN Rev: Not in version control	Sheet: 1 of 1	Project Title: PMP9486	
Drawn By: Ambresh Tripathi	File: PMP9486 REV2.SchDoc	Sheet Title:	
Engineer: Ambresh Tripathi	Contact: http://www.ti.com/support	Assembly Variant: 001	Size: B



H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

~~DNP~~ FID1 ~~DNP~~ FID2 ~~DNP~~ FID3

PCB Number: PMP9486
PCB Rev: E1

PCB
LOGO
Texas Instruments

You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table

Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1
PCB Label
Size: 0.65" x 0.20"

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: PMP9486	Rev: E1	Designed for: Texas Instruments Corporation	Date: 9/4/2014
SVN Rev: Not in version control	Assembly Variant: 001	Project Title: PMP9486	Sheet: 1 of 1
Drawn By:	File: Hardware_ANSI-B_SchDoc	Sheet Title:	Size: B
Engineer: Ambresh Tripathi	Contact: http://www.ti.com/support		



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